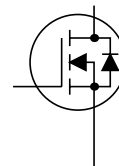
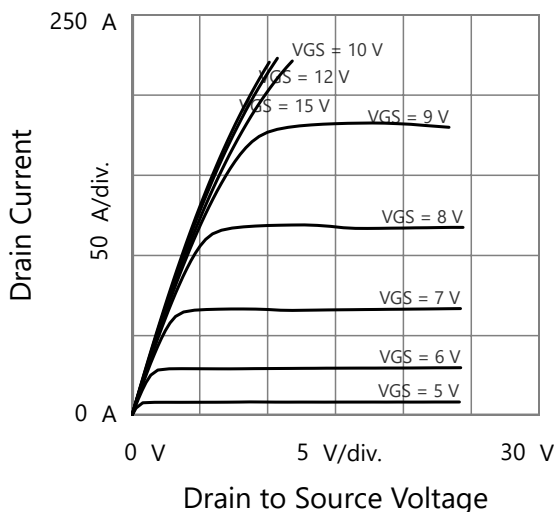


**Part Number:** 4.SIHG73N60E  
**Sample ID:** 4B-1  
**Description:** sample  
**Operator:** YM  
**Measurement Instrument:** B1506AH51\_MY59200135

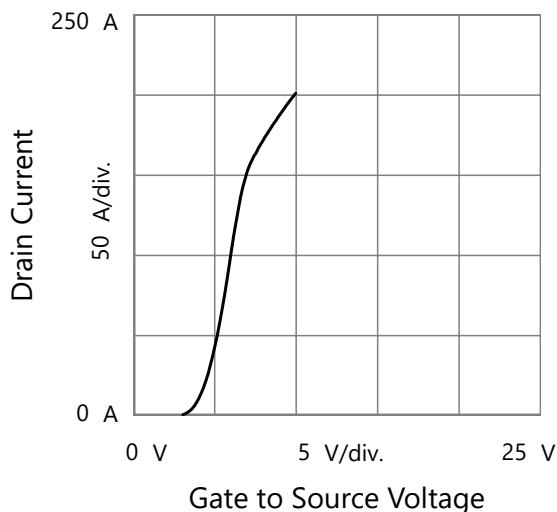


		Maximum Ratings					
Symbol	Parameter	Test Conditions	Value	Unit	Note		
VDSS	Drain to Source Voltage	Tj=-55 °C to 150 °C	600	V			
VGSS	Gate to Source Voltage	Conitnuous	-30 to 30	V			
IDM	Pulsed Drain Current	Tc=25 °C	236	A			
ISM	Pulsed Body Diode Current	Tc=25 °C	200	A			
		Characteristics Parameters					
Symbol	Parameter	Test Conditions	Min.	Act.	Max.	Unit	Note
BVDSS	Drain to Source Breakdown Voltage	VGS=0 V, ID=250 μA	600	660		V	
IDSS	Drain Leakage Current	VDS=600 V, VGS=0 V		3.31 n	1 μ	A	
IGSS	Gate Leakage Current	VGS=30 V, VDS=0 V		54 p	1 μ	A	
IGSS(-)	Gate Leakage Current (-)	VGS=-30 V, VDS=0 V	-1 μ	-862 p		A	
VGS(th)	Gate to Source Threshold Voltage (VDS=VGS)	ID=250 μA	2	2.67	4	V	
RDS(on)	Drain to Source On Resistance	VGS=10 V, ID=36 A, PulseWidth=200 μs		35 m	39 m	ohm	Typ. 0.032 ohm
VSD	Body Diode Forward Voltage	VGS=0 V, IS=36 A, PulseWidth=200 μs		915 m	1.2	V	Typ. 0.9 V
Rg	Gate Resistance	VGS=0 V, f=1 MHz		1.49		ohm	Typ. 1.52 ohm D-open
Ciss	Input Capacitance	VGS=0 V, VDS=100 V, f=100 kHz		8.94 n		F	Typ. 7700 pF
Coss	Output Capacitance	VGS=0 V, VDS=100 V, f=100 kHz		331 p		F	Typ. 320 pF
Crss	Reverse Transfer Capacitance	VGS=0 V, VDS=100 V, f=100 kHz		9.05 p		F	Typ. 5 pF
Qg	Total Gate Charge	Vgs(on)=10 V, Vgs(off)=0 V, Vds=480 V, Id=24 A		238 n	362 n	C	Typ. 241 nC
Qgs	Gate to Source Charge	Vgs(on)=10 V, Vgs(off)=0 V, Vds=480 V, Id=24 A		47.8 n		C	Typ. 48 .nC
Qgd	Gate to Drain Charge	Vgs(on)=10 V, Vgs(off)=0 V, Vds=480 V, Id=24 A		108 n		C	Typ. 98 nC

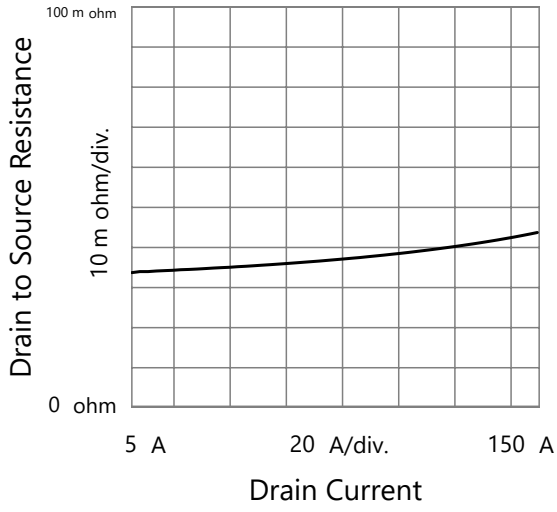
Output Characteristics



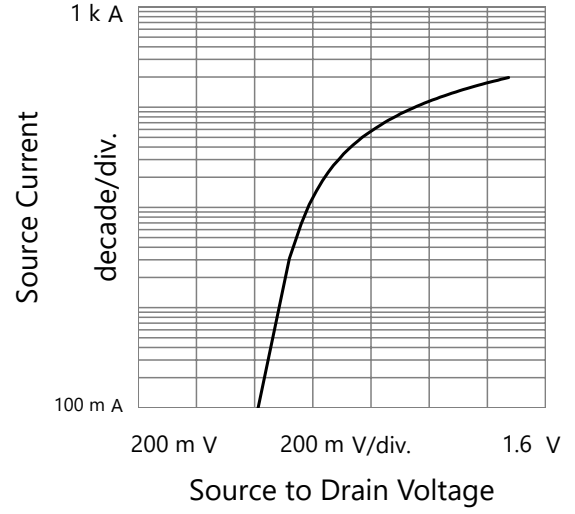
Transfer Characteristics (Vds:26V @ 200A)



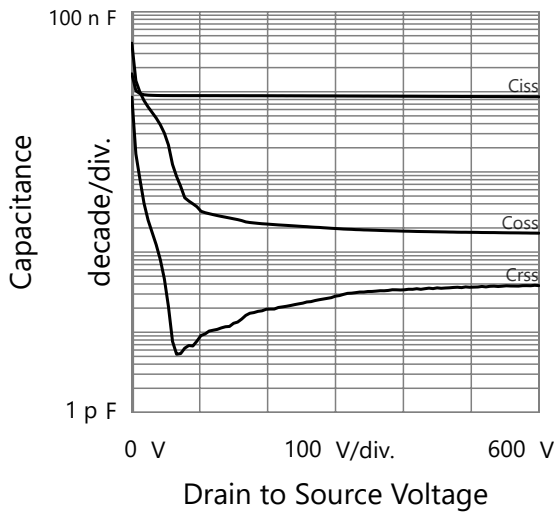
Drain to Source Resistance vs. Drain Current



Body Diode Forward Characteristics



Capacitances



Gate Charge ( Vds:480V, Id:24 A)

